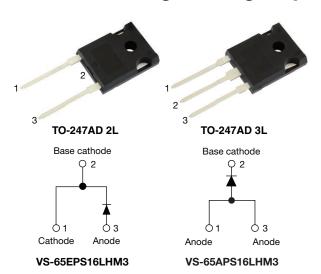


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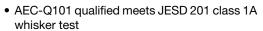
High Voltage Input Rectifier Diode, 65 A



PRIMARY CHARACTERISTICS				
I _{F(AV)}	65 A			
V_R	1600 V			
V _F at I _F	1.17 V			
I _{FSM}	950 A			
T _J max.	150 °C			
Package	TO-247AD 2L, TO-247AD 3L			
Circuit configuration	Single			

FEATURES

- Very low forward voltage drop
- · Glass passivated pellet chip junction





- Flexible solution for reliable AC power rectification
- High surge, low V_F rugged blocking diode for DC charging stations
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- · On-board and off-board EV / HEV battery chargers
- · Renewable energy inverters

DESCRIPTION

High voltage rectifiers optimized for very low forward voltage drop with moderate leakage.

These devices are intended for use in main rectification (single or three phase bridge).

MAJOR RATINGS AND CHARACTERISTICS						
SYMBOL	CHARACTERISTICS	VALUES	UNITS			
I _{F(AV)}	Sinusoidal waveform	65	Α			
V_{RRM}		1600	V			
I _{FSM}		950	Α			
V _F	30 A, T _J = 25 °C	1.0	V			
T _J		-40 to +150	°C			

VOLTAGE RATINGS						
PART NUMBER V _{RRM} , MAXIMUM PEAK REVERSE VOLTAGE V		V _{RSM} , MAXIMUM NON-REPETITIVE PEAK REVERSE VOLTAGE V	I _{RRM} AT 150 °C mA			
VS-65EPS16LHM3	1600	1700	1.3			
VS-65APS16LHM3	1600	1700	1.3			

ABSOLUTE MAXIMUM RATINGS							
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS			
Maximum average forward current	I _{F(AV)}	T _C = 120 °C, 180° conduction half sine wave	65				
Maximum peak one cycle	1	10 ms sine pulse, rated V _{RRM} applied	800	Α			
non-repetitive surge current	IFSM	10 ms sine pulse, no voltage reapplied	950				
Maximum I ² t for fusing	I ² t	10 ms sine pulse, rated V _{RRM} applied	3190	A ² s			
Maximum i-t for fusing	1-1	10 ms sine pulse, no voltage reapplied 4510		A-5			
Maximum I ² √t for fusing	I²√t	t = 0.1 ms to 10 ms, no voltage reapplied	45 100	A²√s			

Revision: 28-Jul-2020 1 Document Number: 96475

VS-65EPS16LHM3, VS-65APS16LHM3

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ELECTRICAL SPECIFICATIONS						
PARAMETER	SYMBOL	TEST CON	IDITIONS	VALUES	UNITS	
Maximum forward voltage drop	V_{FM}	65 A, T _J = 25 °C		1.17	V	
Forward slope resistance	r _t	T 150 °C		3.98	mΩ	
Threshold voltage	V _{F(TO)}	T _J = 150 °C		0.74	V	
Maximum reverse leakage current	1	T _J = 25 °C	V rated V	0.1	mΛ	
iviaximum reverse reakage current	I _{RM}	T _J = 150 °C	V _R = rated V _{RRM}	1.3	mA	

THERMAL - MECHANICAL SPECIFICATIONS							
PARAMETER		SYMBOL	TEST CONDITIONS	VALUES	UNITS		
Maximum junction and storage temper	ature range	T _J , T _{Stg}		-40 to +150	°C		
Maximum thermal resistance, junction	to case	R_{thJC}	DC operation	0.25			
Maximum thermal resistance, junction to ambient		R_{thJA}		40	°C/W		
Typical thermal resistance, case to hea	tsink	R _{thCS}	Mounting surface, smooth, and greased	0.2			
Approximate weight				6	g		
Approximate weight				0.21	oz.		
Mounting torque	minimum			6 (5)	kgf · cm		
Mounting torque	maximum			12 (10)	(lbf \cdot in)		
Mading daving			Case style TO-247AD 2L	65EPS	S16LH		
Marking device			Case style TO-247AD 3L	65APS	S16LH		

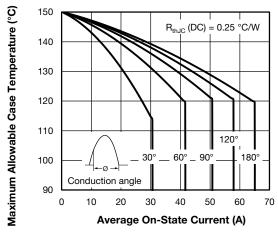


Fig. 1 - Current Rating Characteristics

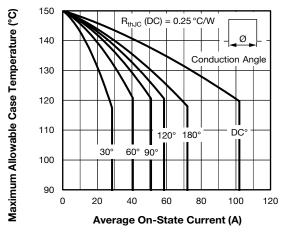


Fig. 2 - Current Rating Characteristics

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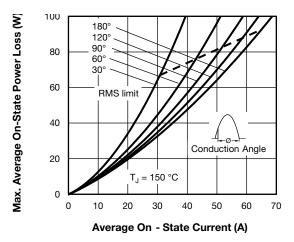


Fig. 3 - Forward Power Loss Characteristics

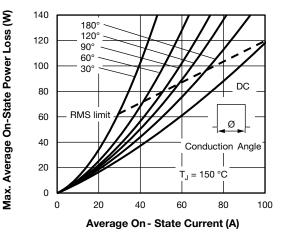


Fig. 4 - Forward Power Loss Characteristics

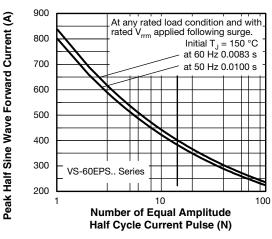


Fig. 5 - Maximum Non-Repetitive Surge Current

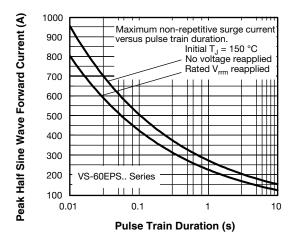


Fig. 6 - Maximum Non-Repetitive Surge Current

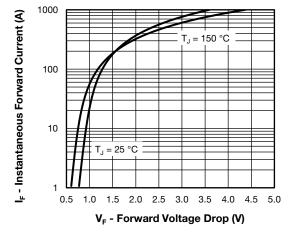


Fig. 7 - Forward Voltage Drop Characteristics

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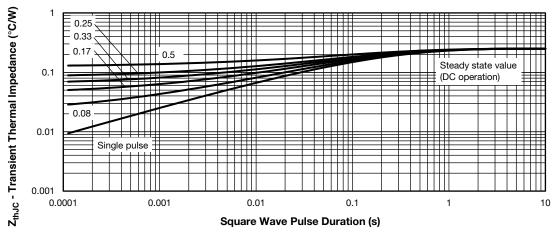
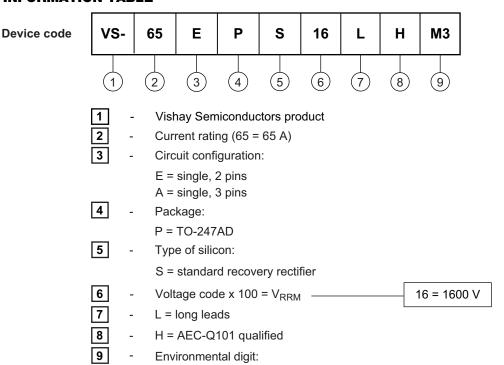


Fig. 8 - Thermal Impedance Z_{thJC} Characteristics

ORDERING INFORMATION TABLE



ORDERING INFORMATION (Example)						
PREFERRED P/N	QUANTITY PER T/R	MINIMUM ORDER QUANTITY	PACKAGING DESCRIPTION			
VS-65EPS16LHM3	25	500	Antistatic plastic tubes			
VS-65APS16LHM3	25	500	Antistatic plastic tubes			

M3 = halogen-free, RoHS-compliant, and terminations lead (Pb)-free

LINKS TO RELATED DOCUMENTS					
Dimensions	TO-247AD 2L	www.vishay.com/doc?95536			
Dimensions ——	TO-247AD 3L	www.vishay.com/doc?95626			
Dout movicing information	TO-247AD 2L	www.vishay.com/doc?95648			
Part marking information ——	TO-247AD 3L	www.vishay.com/doc?95007			
SPICE model		www.vishay.com/doc?96780			

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TO-247AD 2L

DIMENSIONS in millimeters and inches



View B

SYMBOL	MILLIN	IETERS	INC	HES	NOTES
STWIDUL	MIN.	MAX.	MIN.	MAX.	NOTES
Α	4.65	5.31	0.183	0.209	
A1	2.21	2.59	0.087	0.102	
A2	1.50	2.49	0.059	0.098	
b	0.99	1.40	0.039	0.055	
b1	0.99	1.35	0.039	0.053	
b2	1.65	2.39	0.065	0.094	
b3	1.65	2.34	0.065	0.092	
С	0.38	0.89	0.015	0.035	
c1	0.38	0.84	0.015	0.033	
D	19.71	20.70	0.776	0.815	3
D1	13.08	-	0.515	-	4
D2	0.51	1.35	0.020	0.053	

Section C - C, D - D

SYMBOL	MILLIN	IETERS	INC	HES	NOTES
STINIBUL	MIN.	MAX.	MIN.	MAX.	NOTES
Е	15.29	15.87	0.602	0.625	3
E1	13.46	-	0.53	-	
е	5.46	BSC	0.215	BSC	
ØK	0.2	254	0.0	10	
L	19.81	20.32	0.780	0.800	
L1	3.71	4.29	0.146	0.169	
ØΡ	3.56	3.66	0.14	0.144	
Ø P1	-	6.98	-	0.275	
Q	5.31	5.69	0.209	0.224	
R	4.52	5.49	0.178	0.216	
S	5.51	BSC	0.217	BSC	
			•	•	

Notes

- (1) Dimensioning and tolerancing per ASME Y14.5M-1994
- (2) Contour of slot optional
- (3) Dimension D and E do not include mold flash. These dimensions are measured at the outermost extremes of the plastic body
- (4) Thermal pad contour optional with dimensions D1 and E1
- (5) Lead finish uncontrolled in L1
- (6) Ø P to have a maximum draft angle of 1.5 to the top of the part with a maximum hole diameter of 3.91 mm (0.154")
- (7) Outline conforms to JEDEC® outline TO-247 with exception of dimension A min., D, E min., Q min., S, and note 4



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TO-247AD 3L

DIMENSIONS in millimeters and inches



View B

	MILLIN	INC	HES		
SYMBOL	IVIILLIIV	IETEKS	INC	пЕЭ	NOTES
01111202	MIN.	MAX.	MIN.	MAX.	
Α	4.65	5.31	0.183	0.209	
A1	2.21	2.59	0.087	0.102	
A2	1.50	2.49	0.059	0.098	
b	0.99	1.40	0.039	0.055	
b1	0.99	1.35	0.039	0.053	
b2	1.65	2.39	0.065	0.094	
b3	1.65	2.34	0.065	0.092	
b4	2.59	3.43	0.102	0.135	
b5	2.59	3.38	0.102	0.133	
С	0.38	0.89	0.015	0.035	
c1	0.38	0.84	0.015	0.033	
D	19.71	20.70	0.776	0.815	3
D1	13.08	-	0.515	-	4

Section C - C, D - D, E - E

SYMBOL	MILLIMETERS		INC	NOTES	
STIVIBOL	MIN.	MAX.	MIN.	MAX.	NOTES
D2	0.51	1.30	0.020	0.051	
E	15.29	15.87	0.602	0.625	3
E1	13.46	-	0.53	-	
е	5.46	BSC	0.215	BSC	
ØΚ	0.2	0.254)10	
L	19.81	20.32	0.780	0.800	
L1	3.71	4.29	0.146	0.169	
ØΡ	3.56	3.66	0.14	0.144	
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S	5.51 BSC		0.217	BSC	
		<u> </u>	<u> </u>	<u> </u>	

Notes

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